

## Intel Presents PC Plans at Computex

Written by Marco Attard  
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Intel shows off the next generation 14nm Core M (aka Broadwell) processors at Computex-- a chip lineup designed for fanless device use the company claims is its most energy-efficient yet.



The Core M reveal was accompanied by "Llama Mountain," a 2-in-1 fanless PC reference design. The amusingly named device features a 12.5-inch display, weighs 670g and is all of 7.2mm thick sans detachable keyboard.

In comparison the similarly-sized [Surface Pro 3](#) is 7.6mm thick and 800g heavy.

This is not the first Broadwell appearance, mind-- not when the CPU lineup has been [delayed to ship just in time for the holiday season...](#)



Moving on to other PC formats Computex sees Intel reveal the 4th generation Core i7 and i5 "K" SKU, the first from the company to carry 4 cores clocked at up to 4GHz. Aimed at the enthusiast market, the desktop processors also promise higher performance and overclocking capabilities.

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Another Intel plan involves RealSense 3D camera technology. The company says developers will get the RealSense 2014 SDK on Q3 2014, and it hopes the technology will be integrated in a larger number of 2-in-1, all-in-one and tablet devices.

"The lines between technology categories are blurring as the era of integrated computing takes hold where form factor matters less than the experience delivered when all devices are connected to each other and to the cloud," Intel says. "Whether it's a smartphone, smart shirt, ultra-thin 2 in 1 or a new cloud service delivered to smart buildings outfitted with connected systems, together Intel and the Taiwan ecosystem have the opportunity to accelerate and deliver the value of a smart, seamlessly connected and integrated world of computing."

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